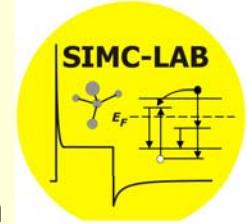


Institute of Electronic Materials Technology



Joint Laboratory for Characterisation
of Defect Centres in Semi-Insulating Materials

Characterisation of defect centres in epitaxial silicon irradiated with high proton fluences

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Outline

- Samples – radiation detectors based on epitaxial silicon
- Effect of high proton fluence on detectors electrical characteristics
- Details of HRPITS measurements
- HRPITS images of spectral fringes for radiation defects in standard and oxygenated epitaxial layers – effect on the high proton fluence on the defect structure of as-irradiated material
- Conclusions

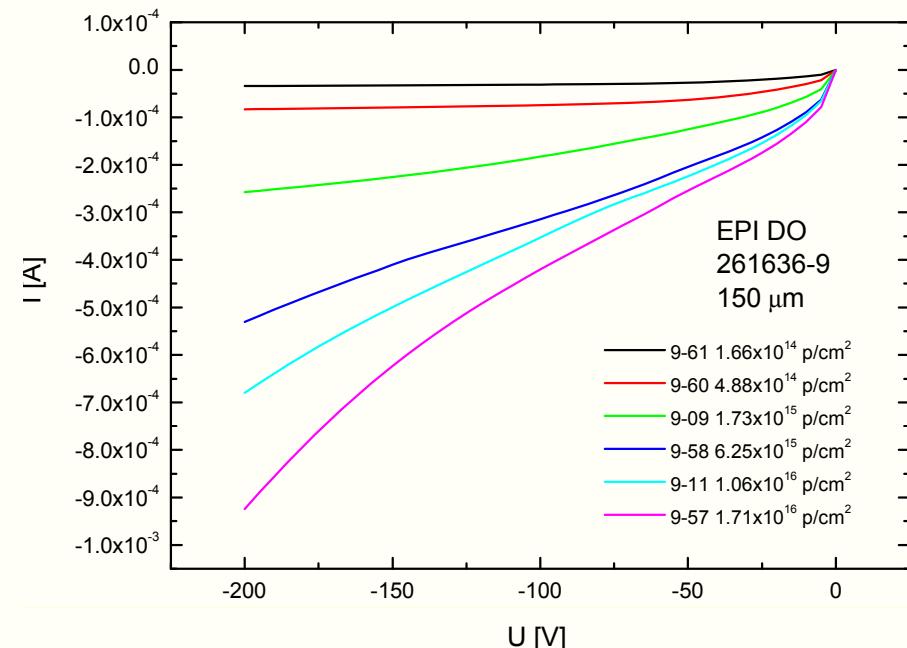
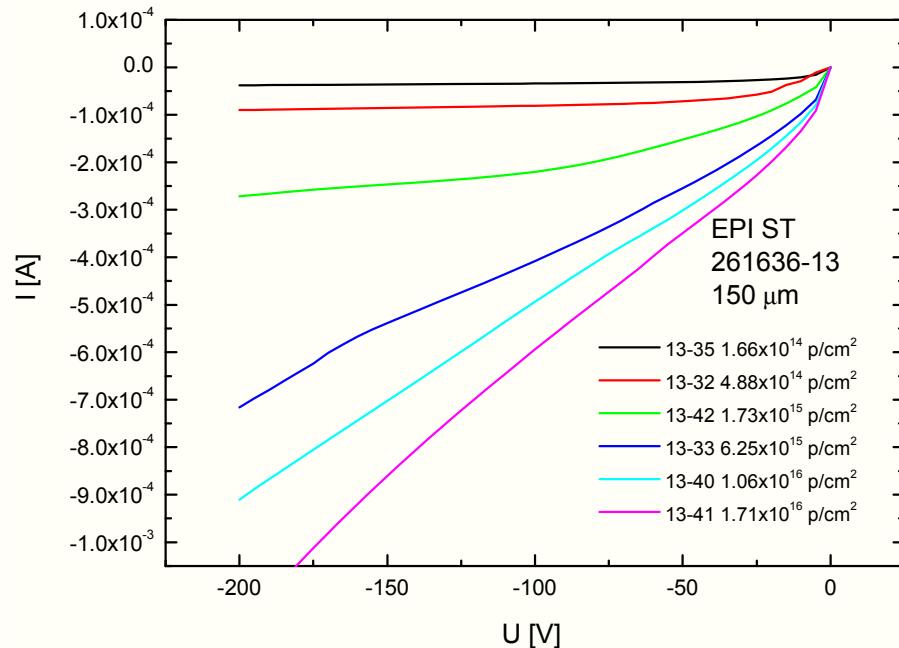
Samples

- Epitaxial detectors fabricated by CiS, Erfurt (Germany)
Process: 261636-13 CiS standard (label - ST)
Process: 261636-9 CiS oxygenated (label – DO)
- Active epitaxial layers - ITME Si epi., $<100>$, *n*-type,
 $500 \Omega\text{cm}$, $150 \mu\text{m}$
- 24 GeV/c proton irradiation, CERN PS source
Fluences: 1.6×10^{14} , 5×10^{14} , 1.6×10^{15} , 5×10^{15} , 1×10^{16} ,
and $1.6 \times 10^{16} \text{ cm}^{-2}$

Effect on high proton fluence on detectors electrical characteristics

Proton fluence range: $1.66 \times 10^{14} - 1.7 \times 10^{16} \text{ cm}^{-2}$

Reverse current



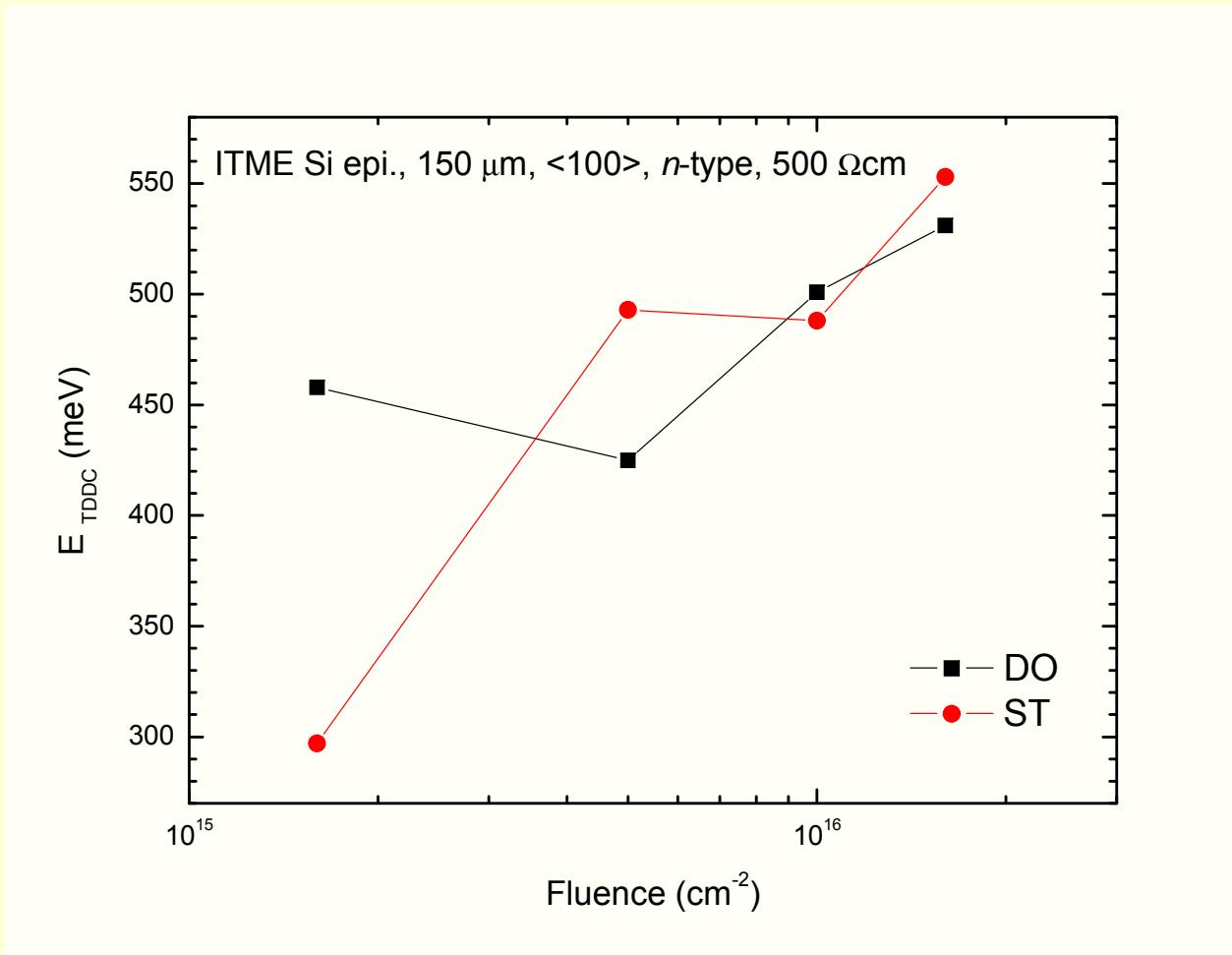
Standard epitaxial layer

Oxygenated epitaxial layer

Effect on high proton fluence on detectors electrical characteristics

Proton fluence range: $1.73 \times 10^{15} - 1.7 \times 10^{16} \text{ cm}^{-2}$

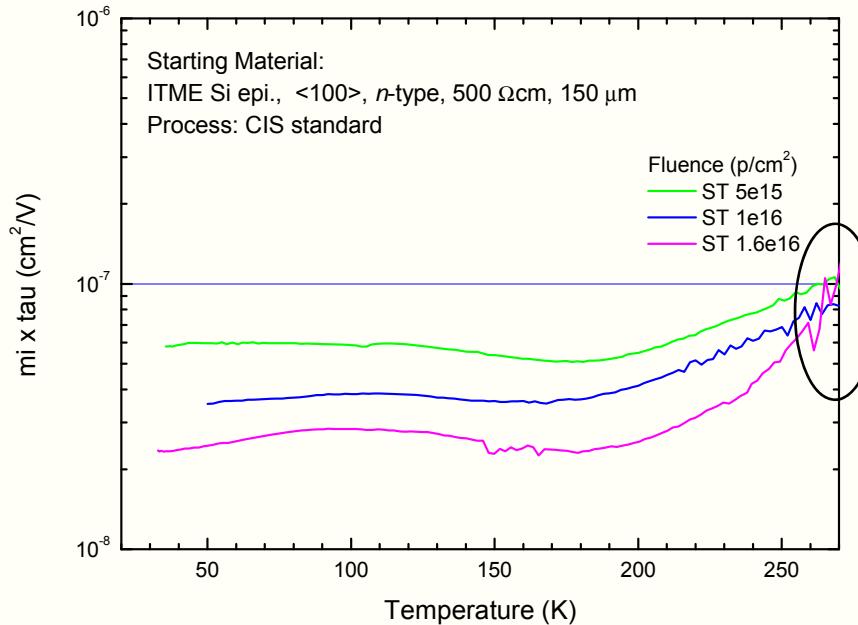
Fermi level position vs proton fluence



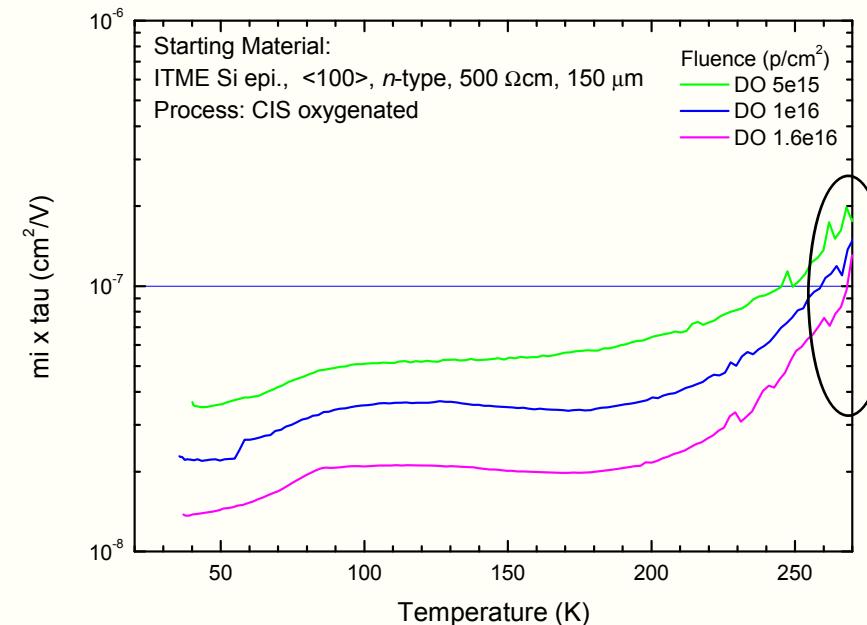
Effect on high proton fluence on detectors electrical characteristics

Proton fluence range: $5 \times 10^{15} - 1.6 \times 10^{16} \text{ cm}^{-2}$

Electron mobility lifetime product



Standard epitaxial layer

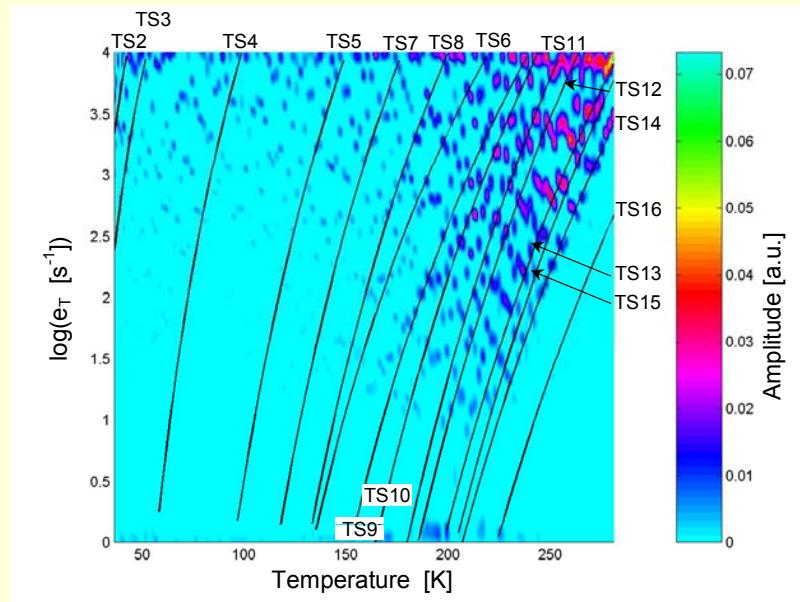
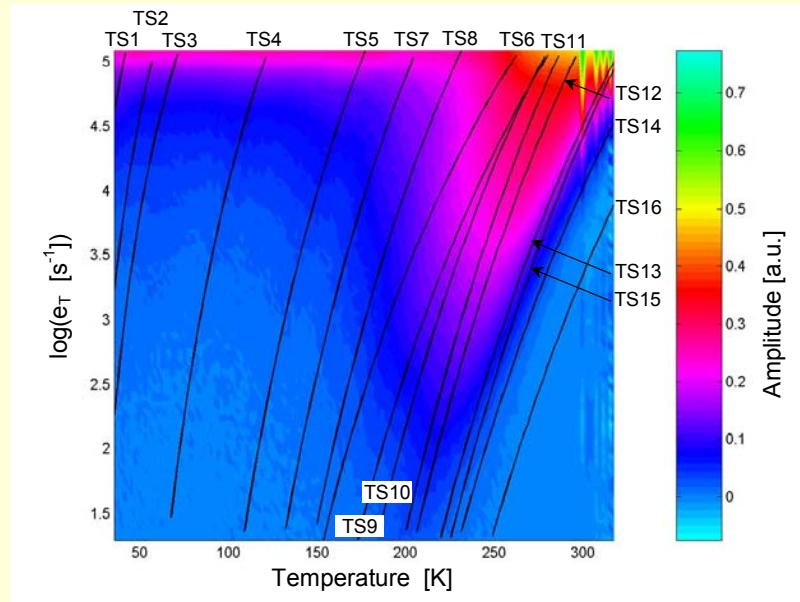


Oxygenated epitaxial layer

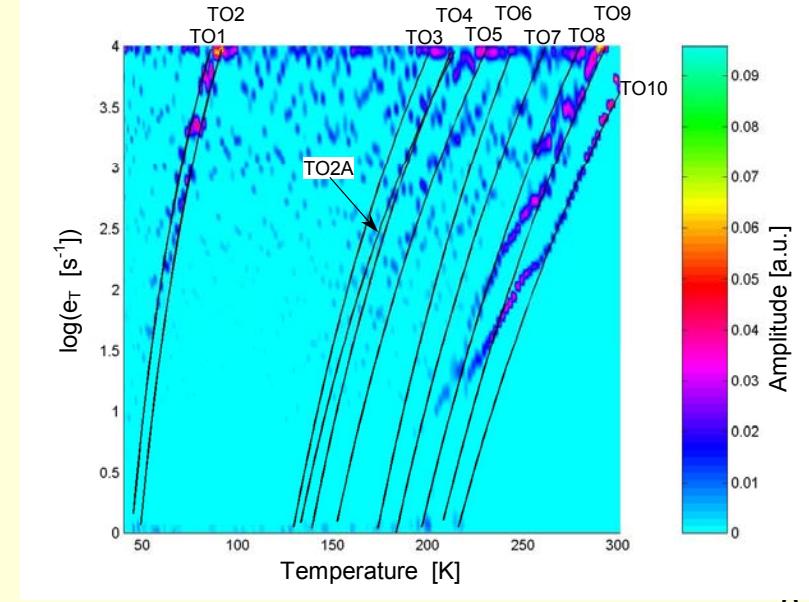
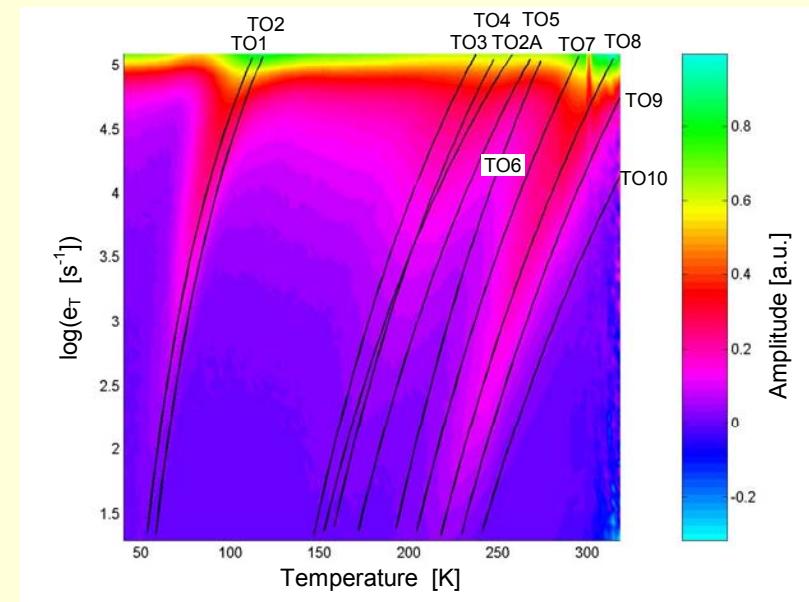
Details of HRPITS measurements

- Temperature range: 30 – 300 K, $\Delta T = 2$ K
- Excitation source: 5 mW, 650 nm laser diode ($h\nu = 1.98$ eV)
- Excitation pulse parameters: Period – 250 ms, Width – 50 ms
- Photon flux: 1.3×10^{17} cm $^{-2}$ s $^{-1}$
- BIAS: 20 V
- Gain: 1×10^6 – 1×10^7 V/A
- AVG: 250 waveforms
- Analysis of photocurrent relaxation waveforms:
 - 2D correlation procedure (multi-window approach) → images of correlation spectral fringes for radiation defect centres
 - 2D inverse Laplace transformation algorithm → images of Laplace fringes for radiation defect centres

HRPITS images – fluence 5×10^{15} p/cm²

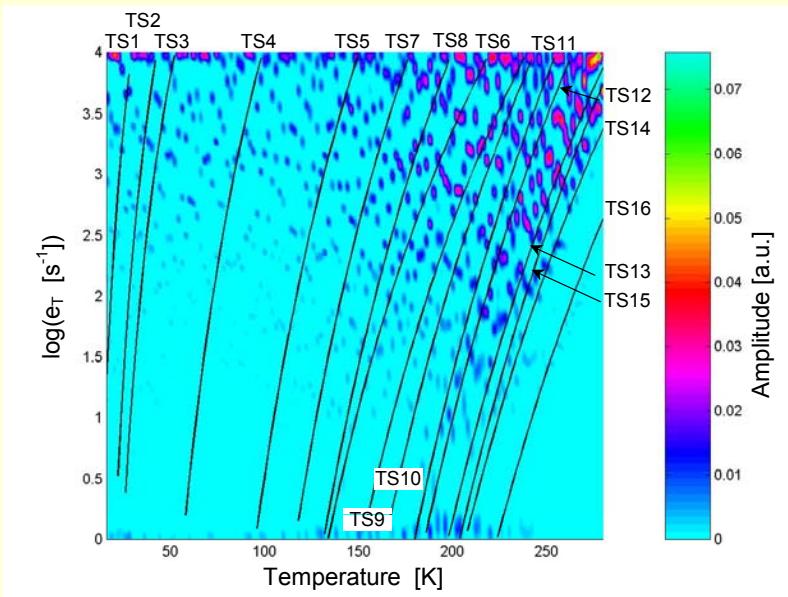
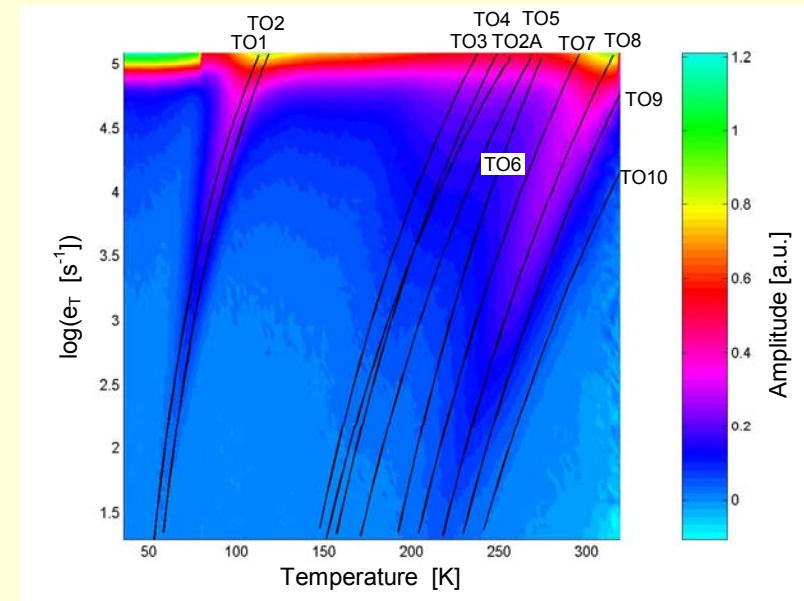
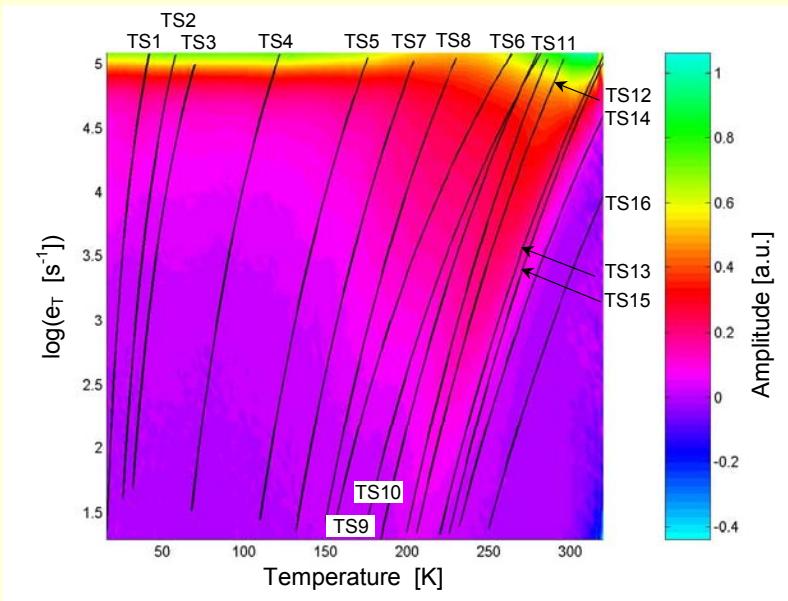


Standard epitaxial layer

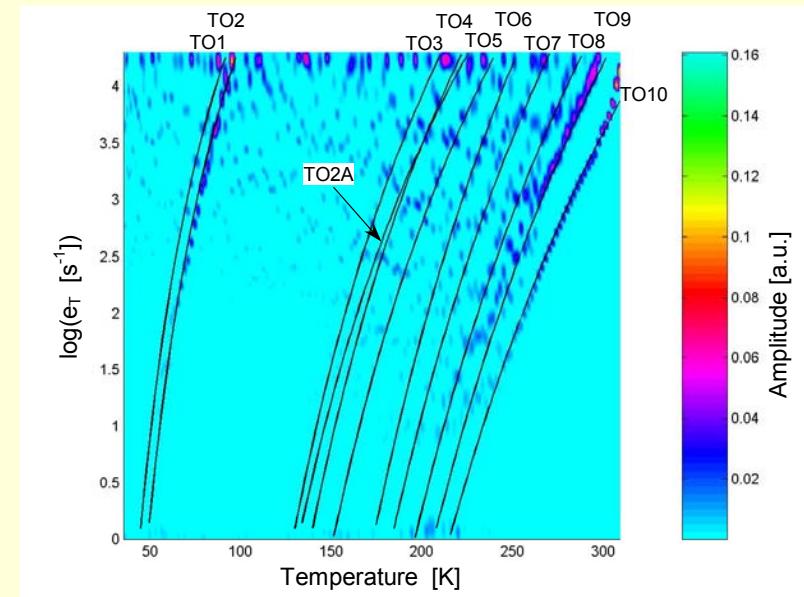


Oxygenated epitaxial layer

HRPITS images – fluence 1×10^{16} p/cm²

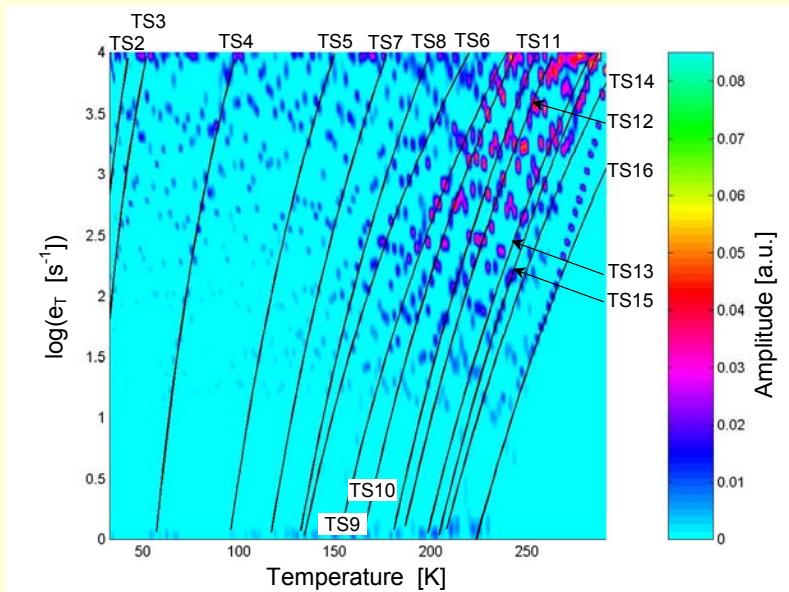
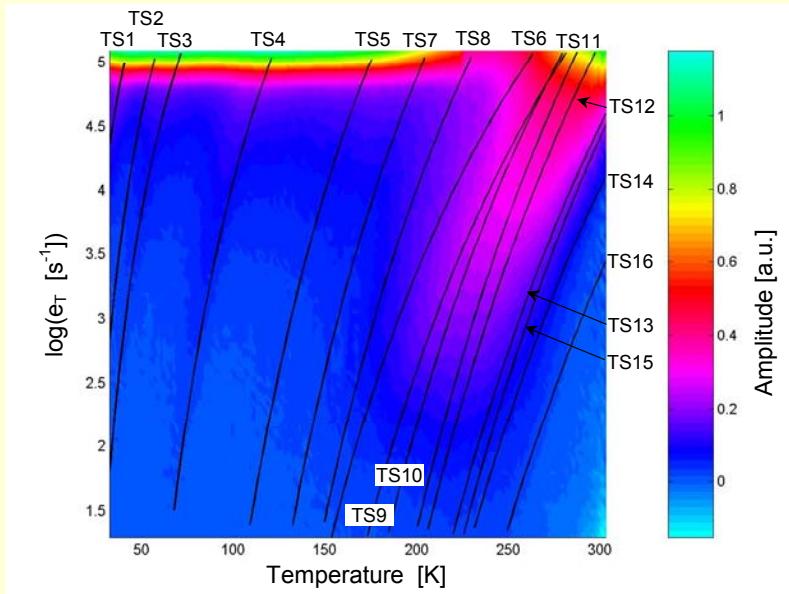


Standard epitaxial layer

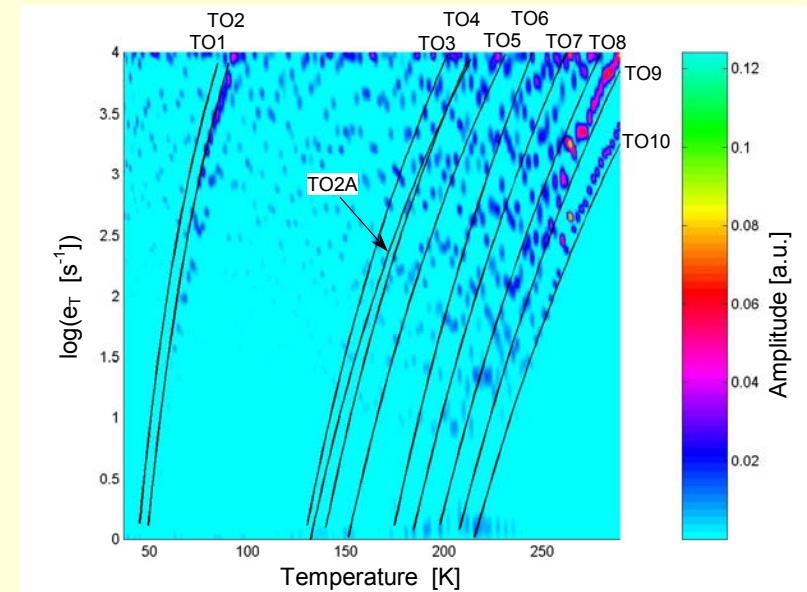
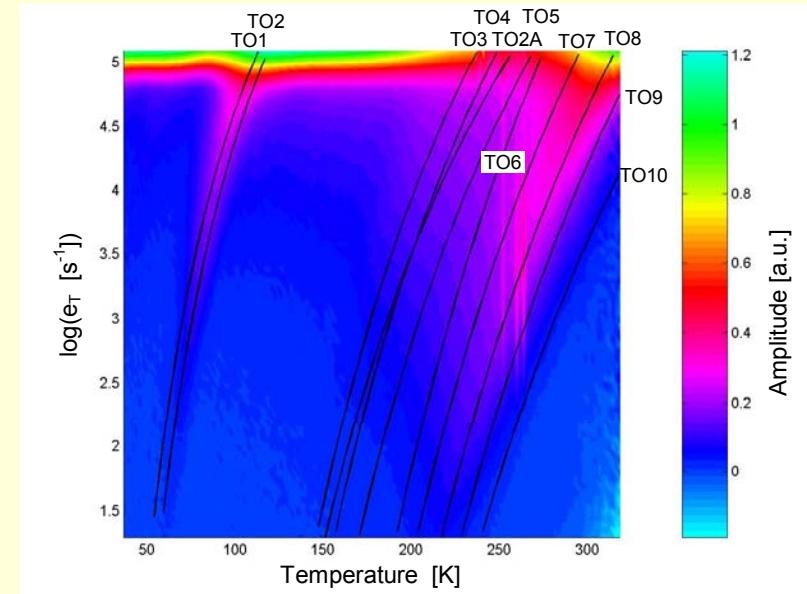


Oxygenated epitaxial layer

HRPITS images – fluence 1.6×10^{16} p/cm²

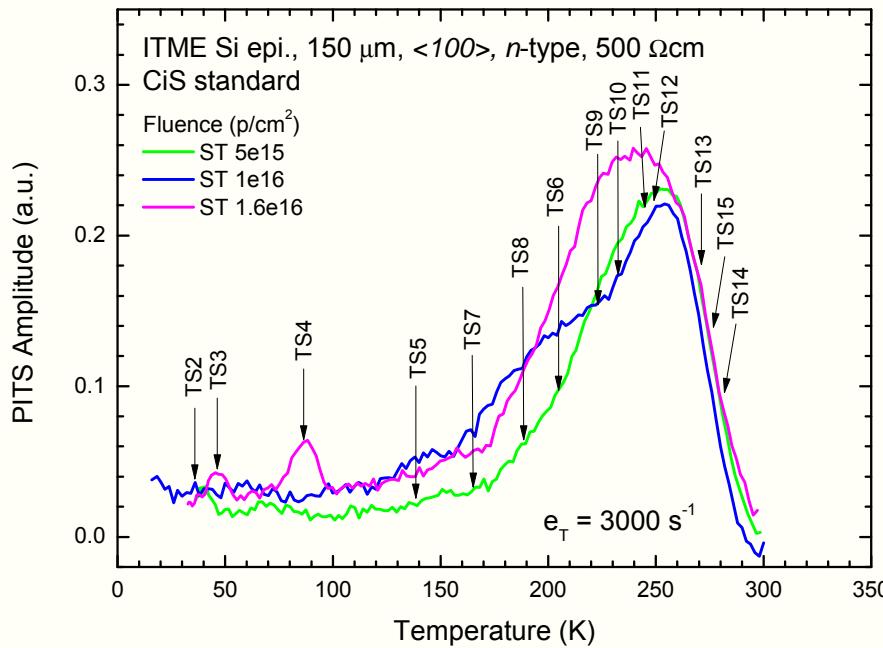


Standard epitaxial layer

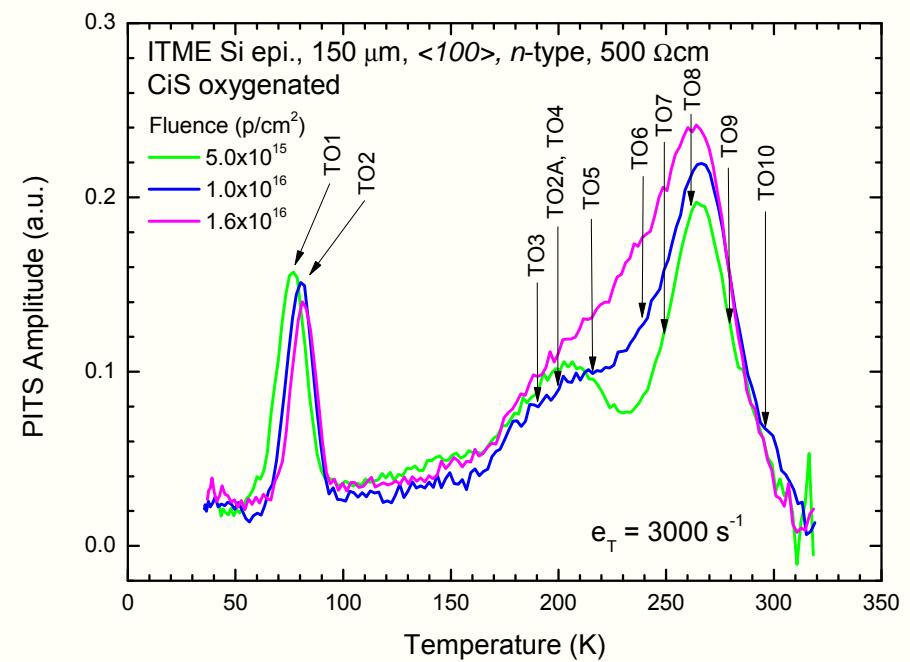


Oxygenated epitaxial layer

1D-HRPITS spectra for standard and oxygenated epitaxial layers irradiated with proton fluences: 5×10^{15} , 1×10^{16} , and $1.6 \times 10^{16} \text{ cm}^{-2}$



Standard epitaxial layer



Oxygenated epitaxial layer

Parameters of defect centers obtained from the HRPITS studies for standard and oxygenated epitaxial silicon irradiated with a fluence of 24GeV/c protons ranging from 5×10^{15} to $1.6 \times 10^{16} \text{ cm}^{-2}$.

Trap label	E_a^* (meV)	A^* ($\text{K}^{-2}\text{s}^{-1}$)	Remarks/Identification
TS1	15±2	(4.3±1.0)x10³	epi ST, shallow donor, <i>e</i>
TS2	25±2	(5.8±1.0)x10³	epi ST, MCz, shallow donor, <i>e</i>
TS3	35±5	(3.8±1.0)x10³	epi ST, MCz, shallow donor or self-interstitial related
TO1	65±3	(5.5±1.5)x10³	epi DO, self-interstitials (I ₂ , I ₃ , I ₄)
TO2	71±3	(9.0±3.0)x10³	epi DO, self-interstitials (I ₂ , I ₃ , I ₄)
TS4	90±5	(5.0±1.0)x10⁴	epi ST, MCz, self-interstitials (I ₂ , I ₃ , I ₄)
TS5	180±10	(1.2±0.5)x10⁶	epi ST, MCz, VO ^{-/+0} , <i>e</i>
TS6, TO2A	242±10	(8.4±1.5)x10⁴	epi ST, DO, MCz, V ₂ ^{2-/+} , <i>e</i>
TS7, TO3	250±10	(1.2±0.7)x10⁶	epi ST, epi DO
TS8, TO4	280±10	(1.7±1.0)x10⁶	epi ST, epi DO
TS9, TO5	305±10	(6.4±4.0)x10⁵	epi ST, epi DO, MCz, IO _i ?
TS10	360±10	(4.0±2.0)x10⁶	epi ST, MCz, C _i O _i ^{+/-0} , <i>h</i>
TS11, TO7	450±10	(7.4±3.0)x10⁷	epi ST, epi DO, MCz, V ₂ ^{-/+0} , <i>e</i>
TS12, TO6	445±10	(1.0±0.3)x10⁸	epi ST, epi DO, MCz, V ₂ O ^{-/+0} , <i>e</i>
TS13, TO8	480±10	(5.0±2.0)x10⁷	epi ST, epi DO, MCz, complex involving V ₄ or V ₅
TS14, TO10	495±10	(1.5±0.5)x10⁷	epi ST, epi DO, vacancy aggregate (V ₃ , V ₄ , V ₅)
TS15, TO9	515±10	(9.2±4.0)x10⁷	epi ST, epi DO, vacancy aggregate (V ₃ , V ₄ , V ₅)
TS16	540±20	(2.9±0.7)x10⁷	epi ST, MCz, vacancy aggregate (V ₃ , V ₄ , V ₅)

* E_a and A - the activation energy and pre-exponential factor in the Arrhenius formula
 $e_T = AT^2 \exp(-E_a/kT)$

Conclusions (1)

- Irradiation with high proton fluences, ranging from 5×10^{15} to $1.6 \times 10^{16} \text{ cm}^{-2}$, results in dramatic degradation of the electrical properties of epitaxial silicon. The mobility lifetime product at 270 K drops to $1 \times 10^{-7} \text{ cm}^2/\text{V}$. The detector leakage current at 200 V goes up to ~ 3 mA. Oxygenation process results in a small increase of the mobility lifetime product and a noticeable decrease in the detector leakage current (to ~ 1 mA).
- The defect levels in the irradiated epitaxial layers have been scanned by the High-Resolution Photoinduced Transient Spectroscopy (HRPITS). To extract the parameters of radiation defect centres from the photocurrent relaxation waveforms, the images of the correlation and Laplace spectral fringes, depicting the temperature dependences of the emission rate of charge carriers for detected defect centres, were created. The spectral fringes for the standard and oxygenated epilayers have been compared.
- In the standard epitaxial layers, 16 radiation defect centres with activation energies ranging from 15 to 540 meV have been revealed. In the oxygenated layers, 11 defect centres with activation energies ranging from 65 to 515 meV have been found.

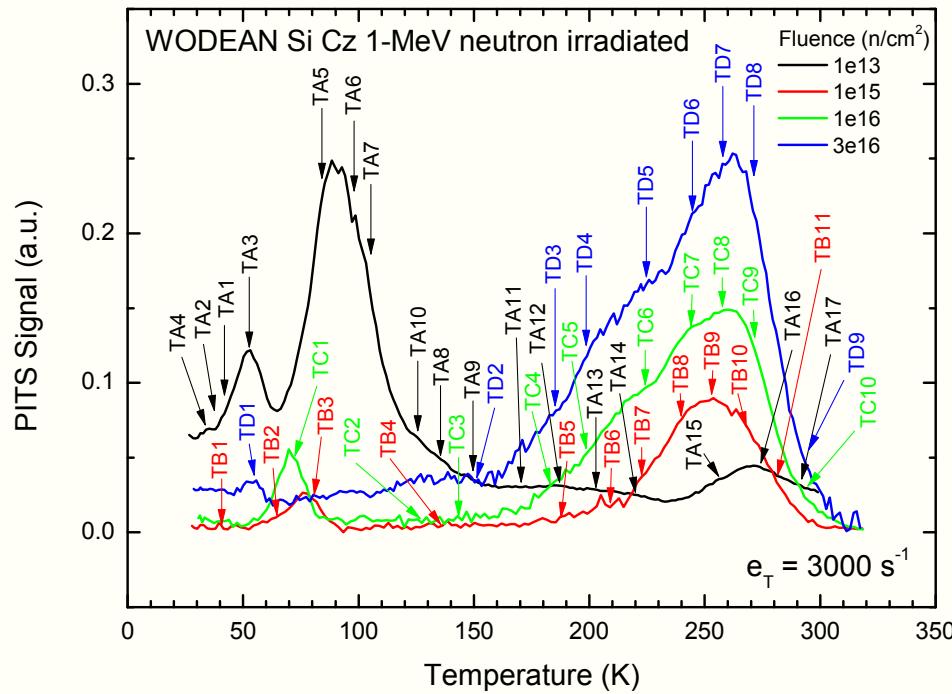
Conclusions (2)

- The electrical properties degradation of the both standard and oxygenated epilayers is mainly due to the formation of 5 deep-level radiation centres with activation energies of 445, 450, 480, 495, and 515 meV. The former two are identified with V_2O and V_2 , respectively. The latter three seem to be related to aggregates of vacancies (V_3 , V_4 , V_5).
- In the oxygenated epilayers, a high concentration of the shallow centres with activation energies of 65 and 71 meV have been observed. These centres are likely to be related to self-interstitial agglomerates.
- Further studies are aimed at determination of the quantitative changes in the defect centres concentrations induced by different proton fluences and oxygenation process. The studies of the epilayers defect structure evolution induced by annealing are also envisaged.

Acknowledgement

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1D-HRPITS spectra for MCz-Si irradiated with 1-MeV neutron fluences ranging from 1×10^{13} to $3 \times 10^{16} \text{ cm}^{-2}$



Trap label	E_a^* (meV)	A^* ($\text{K}^{-2}\text{s}^{-1}$)	Tentative identification
TA1, TB1	19 ± 2	$(2.9 \pm 0.5) \times 10^2$	shallow donor, e
TA2	24 ± 2	$(5.2 \pm 0.5) \times 10^3$	shallow donor, e
TA3	25 ± 2	$(2.7 \pm 0.5) \times 10^2$	shallow donor, e
TA4	27 ± 2	$(3.7 \pm 0.5) \times 10^4$	shallow donor, e
TD1	38 ± 2	$(4.2 \pm 0.5) \times 10^3$	related to self-interstitials (I)
TB2, TC1	49 ± 2	$(2.3 \pm 1.0) \times 10^3$	aggregate of self-interstitials (I ₂)
TA5, TB3	67 ± 2	$(6.2 \pm 0.5) \times 10^3$	aggregate of self-interstitials (I ₃)
TA6	89 ± 2	$(1.4 \pm 0.5) \times 10^4$	aggregate of self-interstitials (I ₄)
TA7	92 ± 2	$(6.4 \pm 0.5) \times 10^3$	$C_iC_s(A)^{\pm 0}, h$
TA8, TB4, TC2, TD2	153 ± 3	$(4.3 \pm 2.0) \times 10^4$	TX3, self-interstitial-oxygen dimer complex ($IO_{i_2}^{\pm 0}$), e
TA9	166 ± 3	$(5.3 \pm 1.0) \times 10^4$	$C_iC_s(A)^{\pm 0}, e$
TA10, TC3	175 ± 5	$(1.9 \pm 0.5) \times 10^6$	$VO^{\pm 0}, e$
TA11,	204 ± 10	$(1.4 \pm 0.5) \times 10^5$	$V_2^{\pm 0}, h$
TA12, TB5, TC4, TD3	222 ± 10	$(1.0 \pm 0.3) \times 10^5$	$V_2^{2\pm 1}, e$
TA13, TB6, TC5, TD4	274 ± 10	$(5.0 \pm 1.0) \times 10^5$	$C_i^{\pm 0}, h$
TA14, TB7	301 ± 10	$(4.8 \pm 1.0) \times 10^5$	$IO_i ?$
TB8, TC6, TD5	350 ± 10	$(2.6 \pm 0.5) \times 10^6$	$C_iO_i^{\pm 0}, h$
TB9, TC7, TD6	430 ± 10	$(2.8 \pm 0.5) \times 10^7$	$V_2O^{\pm 0}, e$
TA15, TB10, TC8, TD7	440 ± 10	$(8.8 \pm 1.0) \times 10^6$	$V_2^{\pm 0}, e$
TC9, TD8	463 ± 10	$(5.7 \pm 1.0) \times 10^6$	complex involving V_4 or V_5 , e
TA16, TB11, TC10, TD9	550 ± 10	$(1.3 \pm 1.0) \times 10^8$	I centre, aggregate of vacancies (V_3), e
TA17	556 ± 20	$(2.7 \pm 1.0) \times 10^7$	aggregate of vacancies (V_5) ?
TA18	563 ± 20	$(8.7 \pm 2.0) \times 10^8$	aggregate of vacancies (V_6) ?